

Electronic Patent Application Fee Transmittal

Application Number:	10519152			
Filing Date:	10-Aug-2005			
Title of Invention:	Porous substrate and its manufacturing method, and gan semiconductor multilayer substrate and its manufacturing method			
First Named Inventor/Applicant Name:	Masatomo Shibata			
Filer:	Paul J. Esatto/Vivian Henriquez			
Attorney Docket Number:	23165			
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Basic Filing:				
Pages:				
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Miscellaneous-Filing:				
Petition:				
Petition-revive unintent. abandoned appl	1453	1	1620	1620
Patent-Appeals-and-Interference:				
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Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
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Total in USD (\$)				1620